

Enhanced and high temperature ACTT power switch

Rev.02 - 22 September 2021

Product data sheet

1. General description

AC Thyristor Triac power switch in a TO220 plastic package with self-protective clamping capabilities against low and high energy transients. This "series CTN" triac will commutate the full RMS current at the maximum rated junction temperature ($T_{j(max)}$ = 150 °C) without the aid of a snubber. It is used in applications where "high junction operating temperature capability" is required.

2. Features and benefits

- Clamping structure ensuring safe high over-voltage withstand capability
- High junction operating temperature capability (T_{i(max)} = 150 °C)
- High minimum I_{GT} for guaranteed immunity to gate noise
- Full cycle AC conduction
- Over-voltage withstand capability to IEC 61000-4-5
- Pin compatible with standard triacs
- Protective self turn-on capability for high energy transients
- · Safe clamping capability for low energy over-voltage transients
- Less sensitive gate for high noise immunity
- Triggering in three quadrants only
- Planar passivated for voltage ruggedness and reliability
- High commutation capability with maximum false trigger immunity
- Very high immunity to false turn-on by dV/dt and IEC 61000-4-4 fast transient
- Package is RoHS compliant
- Package meets UL94V0 flammability requirement

3. Applications

- Electronic themostats (heating and cooling)
- High power motor controls e.g washing machine and vacuum cleaners
- Rectifier-fed DC inductive loads e.g DC motors and solenoids
- Refrigeration and air conditioning compressors
- Applications subject to high temperature (T_{j(max)} = 150 °C)

4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	-	800	V
$I_{T(RMS)}$	RMS on-state current	full sine wave; T _{mb} ≤ 126 °C; <u>Fig. 1;</u> <u>Fig. 2; Fig. 3</u>	-	-	16	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; Fig. 4; Fig. 5	-	-	140	A
		full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms	-	-	150	А
T _j	junction temperature		-	-	150	°C
V _{PP}	peak pulse voltage	T _j = 25 °C; non-repetitive, off-state; <u>Fig. 6</u>	-	-	2	kV
Static ch	aracteristics	·				
I _{GT}	gate trigger current	V _D = 12 V; I _T = 100 mA; LD+ G+; T _j = 25 °C; <u>Fig. 8</u>	5	-	35	mA
		V _D = 12 V; I _T = 100 mA; LD+ G-; T _j = 25 °C; <u>Fig. 8</u>	5	-	35	mA
		V _D = 12 V; I _T = 100 mA; LD- G-; T _i = 25 °C; <u>Fig. 8</u>	5	-	35	mA

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 10</u>		-	-	30	mA
V _T	on-state voltage	I _T = 20 A; T _j = 25 °C; <u>Fig. 11</u>		-	-	1.5	V
V_{CL}	clamping voltage	$I_{CL} = 0.1 \text{ mA}; t_p = 1 \text{ ms}; T_j = 25 \text{ °C}$		850	-	-	V
Dynamic	characteristics						
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit		1500	-	-	V/µs
		V_{DM} = 536 V; T _j = 150 °C; exponential waveform; gate open circuit		1000	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$V_D = 400 \text{ V}; T_j = 150 \text{ °C}; I_{T(RMS)} = 16 \text{ A}; dV_{com}/dt = 20 \text{ V}/\mu s; (snubberless condition); gate open circuit$		12	-	-	A/ms
		$V_D = 400 \text{ V}; \text{T}_\text{j} = 150 ^\circ\text{C}; \text{I}_{\text{T(RMS)}} = 16 \text{ A}; $ $dV_{\text{com}}/dt = 10 \text{ V}/\mu\text{s}; \text{ gate open circuit}$		15	-	-	A/ms
		$V_D = 400 \text{ V}; \text{T}_\text{j} = 150 ^\circ\text{C}; \text{I}_{\text{T(RMS)}} = 16 \text{ A}; $ $dV_{\text{com}}/dt = 1 \text{ V}/\mu\text{s}; \text{ gate open circuit}$		20	-	-	A/ms

5. Pinning information

Table 2. P	inning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	СМ	common	mb	LD
2	LD	load		
3	G	gate		G
mb	LD	mounting base; load		ĊM 003aaf296

6. Ordering information

Table 3. Ordering information

U						
Type number	Package	Orderable part number	Packing	Small packing	Package	Package
	Name		method	quantity	version	issue date
ACTT16-800CTN	TO220	ACTT16-800CTNQ	Tube	50	SOT78	13-Jun-2008

7. Marking

Table 4. Marking codes

Type number	Marking codes		
	Assembly factory: d	Assembly factory: A	
ACTT16-800CTN	ACTT16 800CTN PJdxxxx xx	ACTT16 800CTN PJAxxxx xx	

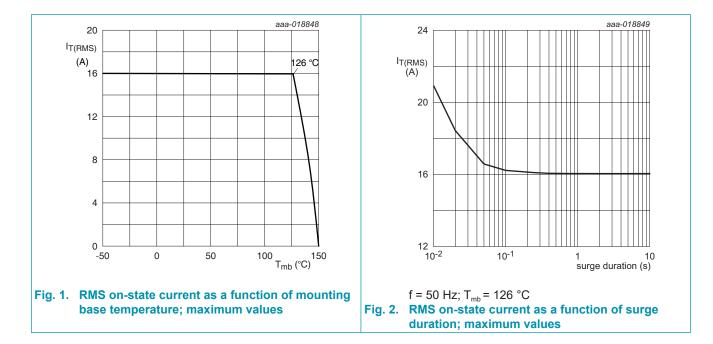
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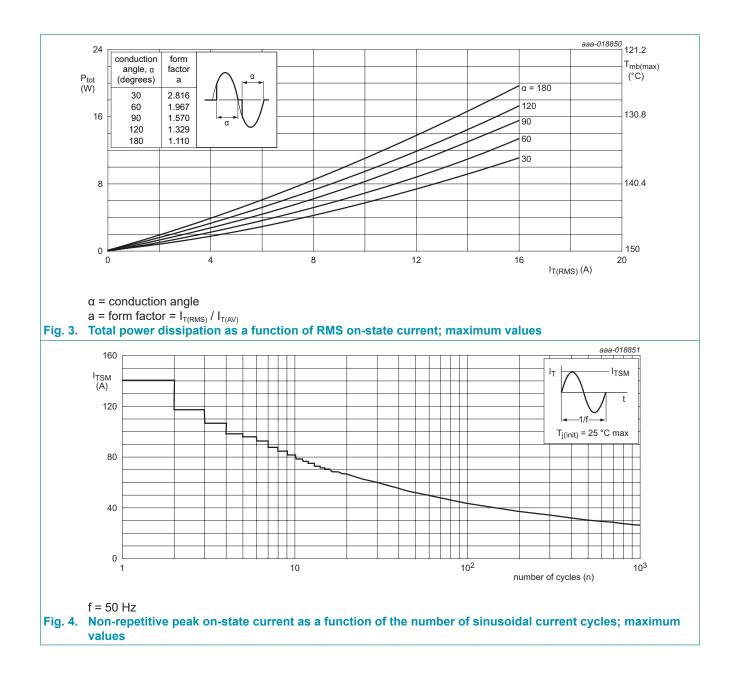
8. Limiting values

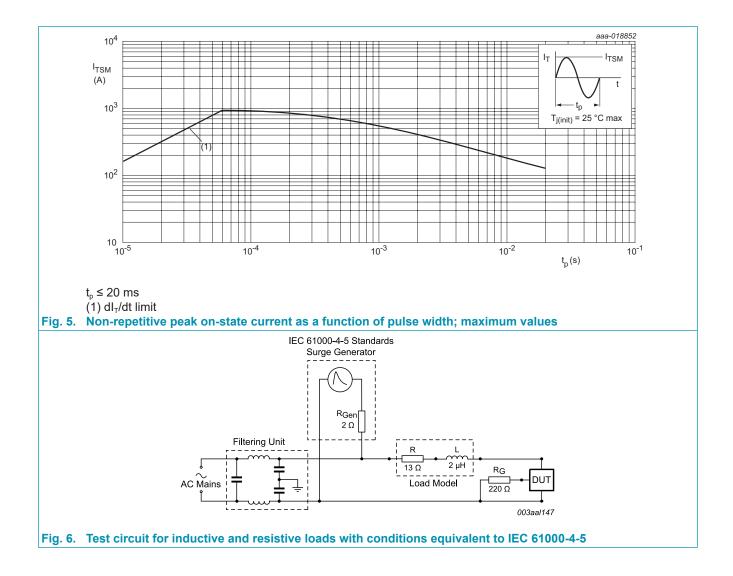
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{mb} ≤ 126 °C; <u>Fig. 1;</u> <u>Fig. 2</u> ; <u>Fig. 3</u>	-	16	A
I _{TSM}	non-repetitive peak on-state current	full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; <u>Fig. 4; Fig. 5</u>	-	140	А
		full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms	-	150	А
l ² t	l ² t for fusing	t _p = 10 ms; sine-wave pulse	-	98	A ² s
dl _⊤ /dt	rate of rise of on-state current	I _G = 70 mA	-	100	A/µs
I _{GM}	peak gate current	t _p = 20 μs	-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	150	°C
V _{PP}	peak pulse voltage	T _i = 25 °C; non-repetitive, off-state; <u>Fig. 6</u>	-	2	kV



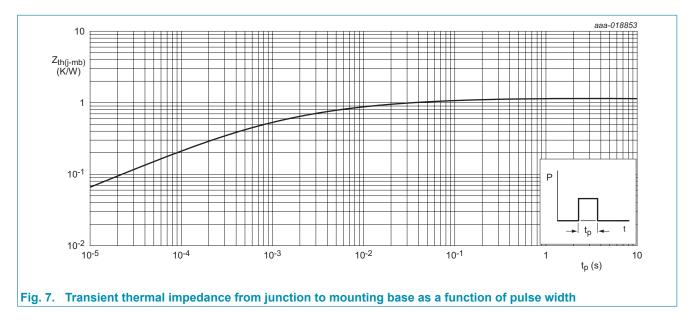




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9. Thermal characteristics

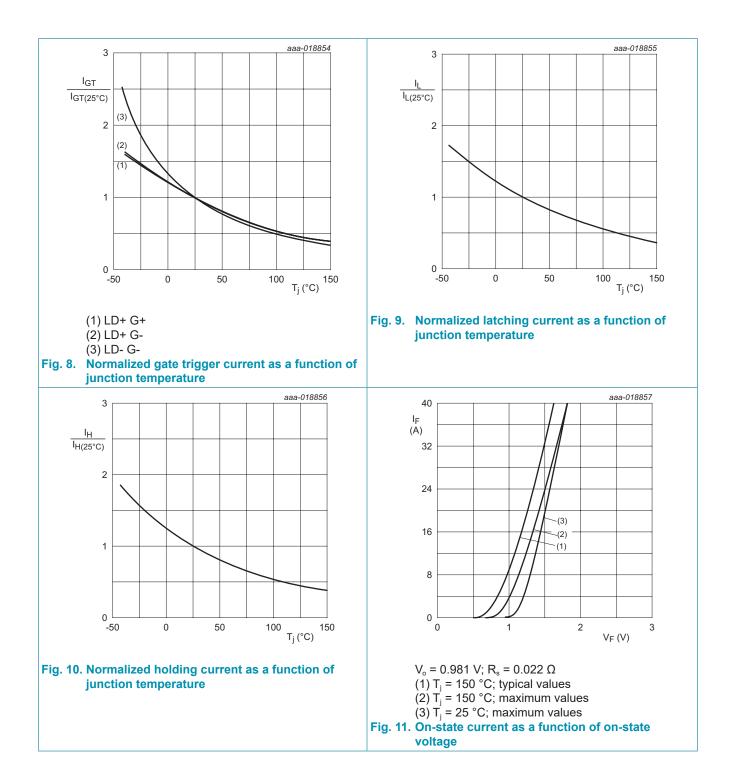
Fable 6. Thermal characteristics								
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
$R_{th(j-mb)}$	thermal resistance	full cycle; <u>Fig. 7</u>		-	-	1.2	K/W	
	from junction to mounting base	half cycle		-	-	1.7	K/W	
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air		-	60	-	K/W	

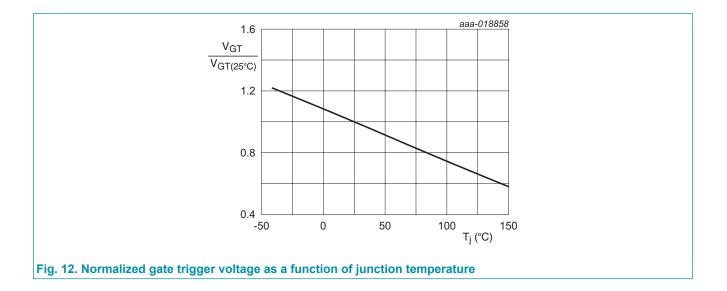


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10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	V_{D} = 12 V; I _T = 100 mA; LD+ G+; T _j = 25 °C; Fig. 8	5	-	35	mA
		V_{D} = 12 V; I _T = 100 mA; LD+ G-; T _j = 25 °C; Fig. 8	5	-	35	mA
		V_{D} = 12 V; I _T = 100 mA; LD- G-; T _j = 25 °C; <u>Fig. 8</u>	5	-	35	mA
I _L	latching current	$V_{D} = 12 \text{ V}; \text{ I}_{G} = 100 \text{ mA}; \text{ LD+ G+};$ $T_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 9}$	-	-	40	mA
		V_{D} = 12 V; I _G = 100 mA; LD+ G-; T _j = 25 °C; <u>Fig. 9</u>	-	-	50	mA
		$V_{\rm D}$ = 12 V; I _G = 100 mA; LD- G-; T _j = 25 °C; <u>Fig. 9</u>	-	-	40	mA
I _H	holding current			-	30	mA
V _T	on-state voltage	I _T = 20 A; T _j = 25 °C; <u>Fig. 11</u>		-	1.5	V
V _{GT}	gate trigger voltage	V _D = 12 V; I _T = 100 mA; T _j = 25 °C; Fig. 12	-	0.8	1	V
		V _D = 400 V; I _T = 100 mA; T _j = 150 °C	0.2	0.45	-	V
I _D	off-state current	V _D = 800 V; T _j = 25 °C	-	-	10	μA
		V _D = 800 V; T _j = 150 °C	-	-	2	mA
V _{CL}	clamping voltage $I_{CL} = 0.1 \text{ mA}; t_p = 1 \text{ ms}; T_j = 25 \degree C$		850	-	-	V
Dynamic	characteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	1500	-	-	V/µs
		V_{DM} = 536 V; T _j = 150 °C; exponential waveform; gate open circuit	1000	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$V_D = 400 \text{ V}; \text{ T}_j = 150 \text{ °C}; \text{ I}_{T(RMS)} = 16 \text{ A}; $ $dV_{com}/dt = 20 \text{ V}/\mu \text{s}; \text{ (snubberless condition); gate open circuit}$	12	-	-	A/ms
		V_{D} = 400 V; T _j = 150 °C; I _{T(RMS)} = 16 A; dV _{com} /dt = 10 V/µs; gate open circuit	15	-	-	A/ms
		V_{D} = 400 V; T_{j} = 150 °C; $I_{T(RMS)}$ = 16 A; dV _{com} /dt = 1 V/µs; gate open circuit	20	-	-	A/ms

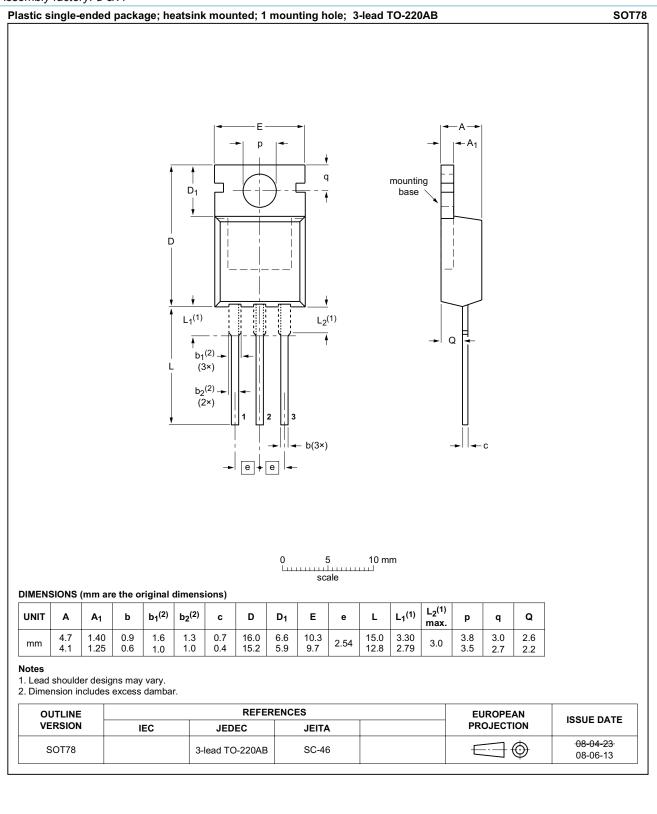




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11. Package outline

Assembly factory: d & A



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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